Large m agnetoresistance at room -tem perature in sem iconducting polym er sandw ich devices

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We report on the discovery of a large, room temperature magnetoresistance (MR) elect in poly uorene sandwich devices in weak magnetic elds. We characterize this elect and discuss its dependence on voltage, temperature, Imm thickness, electrode materials, and (unintentional) impurity
concentration. We usually observed negative MR, but positive MR can also be achieved under high
applied electric elds. The MR elect reaches up to 10% at elds of 10mT at room temperature.
The elect shows only a weak temperature dependence and is independent of the sign and direction
of the magnetic eld. We not that the elect is related to the hole current in the devices.

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O rganic conjugated materials have been used to manufacture promising devices such as organic light-emitting diodes (OLEDs) [1], photovoltaic cells [2] and elde ect transistors [3]. Recently there has been growing interest in spin [4, 5, 6] and magnetic eld e ects [7, 8, 9] in these materials in order to assess the possibility of using them in magnetoresistive device applications. During the study of poly uorene (PFO) sandwich devices [8] we surprisingly discovered a large and intriguing magnetoresistance (MR) e ect. In our best devices this MR e ect reaches up to 10% (de ned as (R (B) R(0)=R(0)) at elds, B = 10m T at room temperature. To the best of our know ledge, this constitutes a record value in bulk materials. In the following we experimentally characterize the eect. At the end of the paper, we will discuss possible mechanisms that cause the MR e ect.

Our thin Im sandwich devices consist of the polymerPFO (poly (9,9-dioctyl uorenyl-2,7-diyl) end capped with N,N-B is (4-m ethylphenyl)-4-aniline, see Fig. 1 inset) sandwiched between a top and bottom electrode. The polymer was purchased from American Dye Source, Inc (ADS), as well as from H.W. Sands (HWS) and was used as received. The polymeric lm was fabricated by spin-coating from toluene solution at 2000 rpm. For varying the lm thickness, di erent concentrations were used, namely 7 to 30 mg/ml. The bottom electrode consisted of either indium -tin-oxide (ITO) covered glass, poly (3,4-ethylenedioxythiophene) poly (styrenesulfonate) (PEDOT) spin-coated on top of ITO, or Au evaporated onto a glass slide. The top contact, either Al, Ca (covered by a capping layer of Al) or Au, was evaporated through a shadow mask (active area: 1 mm²) at a base pressure of 10 6 m bar. All manufacturing steps were performed inside a nitrogen glove-box. The MR measurements were perform ed with the sample mounted on the cold nger of

FIG.1: M agnetoresistance, R=R curves, m easured at room tem perature in an ITO (30 nm)/PEDOT (100 nm)/PFO (150 nm)/Ca (50 nm including capping layer) device at dierent voltages. The inset shows the device resistance as a function of the applied voltage.

a closed-cycle He cryostat located between the poles of an electrom agnet. The M R was determined by measuring the current at a constant applied voltage, V.

Fig. 1 shows measured MR traces in a PFO sandwich device (details are given in the caption) at room—temperature at dierent V.We found that the measured MR traces are independent of the angle between lm plane and applied magnetic eld.Allmeasurements shown were performed with an in-plane magnetic eld.

Fig. 2 shows the dependence of the magnitude of the MR e ect at $100\,\mathrm{m}\,\mathrm{T}$ and $200\,\mathrm{K}$ (to reduce thermaldrift during measurements) on V in a variety of devices using

⁻² Œ -4 voltage (V) -6 9V 7.5V -8 6V -10 5.5V -12 5V -14 -100 -80 -60 -40 -20 0 20 40 60 100 B (mT)

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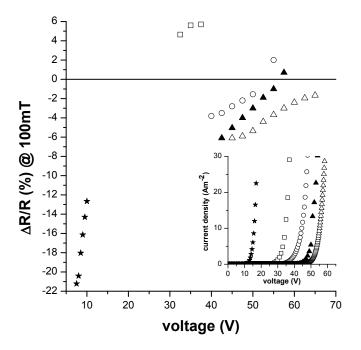


FIG. 2: Dependence of R=R at 100 mT and 200 K on the device voltage in a variety of PFO devices with dierent electrode materials. The inset shows the current-voltage characteristics of these devices. ? is for PEDOT/PFO (150 nm)/Ca, is for ITO/PFO (140 nm)/Ca, N is for ITO/PFO (150 nm)/Au, M is for Au/PFO (150 nm)/Ca, is for ITO/PFO (150 nm)/Ca, is for ITO/PFO (150 nm)/Ca, is for ITO/PFO (150 nm)/Ca at high applied voltages.

di erent electrode materials with a polymer lm thickness of 150nm (details are given in the caption). PE-DOT and Ca are commonly used in OLEDs since they result in relatively small barriers for hole and electron injection, respectively. ITO and Au are other common contacts for hole injection because of their large work function. We used Ca, Al (data not shown) or Au as the top electrode material, resulting in e cient (Ca) or moderately e cient (A1) electron injection or hole-only devices (Au). The current-voltage (IV) characteristics of the measured devices are shown as an inset to Fig. 2. It is seen that the IV curves are strongly non-linear as is usually the case in polymer sandwich devices. We found that both IV and MR curves do not critically depend on whether Au or ITO are used. However, using PE-DOT as the anode results in a signi cant reduction in onset voltage and an increase in the observed MR effect. Both results can be understood considering the decrease in the hole-injection barrier, and therefore the reduction of the interface series resistance, which is the reason that PEDOT is the preferred anode material in OLEDs. Importantly, the observed MR e ect is largely independent of the top electrode (electron in jector) material and occurs also in hole-only devices. This clearly indicates that the MR e ect is due to hole transport, and not connected to electron transport or electron-hole recombination processes that also occur in OLED devices. Most of the data shown is measured in PEDOT/PFO/Ca

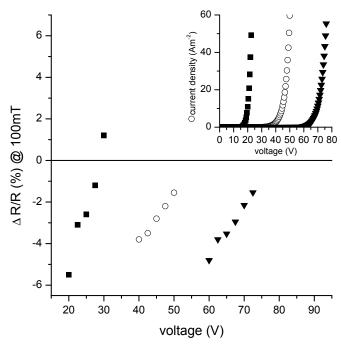


FIG. 3: Dependence of R=R at 100 mT and 200 K on the device voltage in a variety of devices with dierent polymer lm thickness. The inset shows the IV characteristics of these devices. is for an ITO/PFO (60 nm)/Ca device, is for ITO/PFO (140 nm)/Ca, and H is for ITO/PFO (300 nm)/Ca.

devices since these showed the best long term stability.

Fig. 3 shows the dependence of the magnitude of the MR e ect in ITO/PFO/Ca devices with dierent polymer Im thickness (details are given in the caption) at 100 m T and 200 K on V.W e found that the onset voltage in the linear-linear IV plot in these devices is determ ined mostly by the PFO Im thickness. Since similar results (not considering the shift in operating voltage) are achieved independent of PFO Im thickness, this clearly suggests that the observed MR e ect is a bulk, rather than an (electrode) interface e ect. This conclusion is of course further supported by the fact that the MR e ect is observed for PEDOT, ITO and Au anodes. We note that the observation that the MR e ect in PEDOT devices is considerably larger than for Au and ITO devices is not in contradiction with our conclusion, but can be attributed to a reduction in interface series resistance in the device when using PEDOT.

Returning to the data in Fig. 1 it is seen that R=R typically increases in magnitude with increasing device resistance. However, we not that the resistance of our devices decreasesm uch fasterwith increasing V than does the magnitude of the MR e ect. We conjecture that this weak dependence of R=R over several orders of magnitude in R suggests that the "intrinsic" MR is independent of V or current, and that the weak dependence is an "artifact" due to series resistances outside of the PFO $\,$ lm , such as hole-injection (Schottky-like) interface series re-

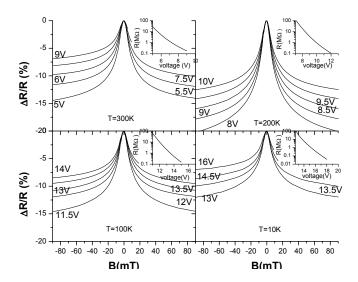


FIG. 4: Magnetoresistance, R=R curves in an PE-DOT/PFO ($150 \, \text{nm}$)/Ca device measured at dierent tem-peratures, namely $10 \, \text{K}$, $100 \, \text{K}$, $200 \, \text{K}$, and $300 \, \text{K}$. The applied voltages are assigned. The insets show the IV characteristics at the dierent temperatures.

sistance. A nother striking result shown in Figs. 2 and 3 is that, in addition to negative MR, positive MR can be observed [8] in ITO and Au anode devices at high V.W e note that we have never observed positive MR in PEDOT devices and speculate that this may be related to the signi cantly reduced onset voltage in this devices. We note that the applied electric elds are very large in polymer sandwich devices (typically 10^5 to $10^6 V = cm$).

Fig. 4 shows MR traces in a PEDOT/PFO/Ca device for four dierent temperatures between 300K and 10K. We not that the magnitude and width of the MR cones are relatively insensitive to temperature. Fig. 4, inset shows the IV curves at the dierent temperatures.

Similar experiments were also performed on devices made from other -conjugated polymers and small molecules and will be reported elsewhere. It is important to address the question whether the MR e ect may be related to (unintentional) in purities, such as left over

catalysts from the polymerization reaction. Elemental analysis performed by ADS of our PFO batches showed signals for only one in purity, namely the catalyst bis (1,5-cyclooctadiene)Nickel (NiCOD) at levels less than 20 ppm. In addition we commissioned 3 new batches of PFO that have been puried to dierent degree after synthesis, resulting in NiCOD content of 21, 177, 683 ppm. Our MR measurements on these badges showed no signicant dependence on NiCOD impurity concentration. In addition, the MR elect in devices made from HWS batches showed no signicant dierence compared to ADS batches. We consider this strong evidence that the MR elect is not related to (unintentional) impurities.

Finally, we want to brie y discuss possible mechanisms to explain the observed M R e ect. W e are fam iliar with the following mechanisms that cause MR: (1) Lorentz force, (2) hopping magnetoresistance [10], (3) electronelectron interaction [11] and (4) weak localization [12]. It appears that mechanisms (1) to (3) cannot explain our MR e ect, because e ects (1) to (3) exclusively lead to positive MR, whereas our e ect is typically negative. We note that the observed MR traces closely resemble MR traces due to weak localization (negative MR) and weak antilocalization (positive MR) well known from the study of di usive transport in metals and sem iconductors [12, 13, 14]. This suggests analyzing the MR data using the theory of weak localization. Such an interpretation however results in several surprising results that cast some doubt on this interpretation [8]. It therefore appears that a novel explanation for the observed MR e ect needs to be found.

In sum m ary, we discovered a large M R e ect in PFO sandwich devices. The magnitude of the e ect is several percent at elds of order 10m T and can be either positive or negative, dependent on V. The e ect is independent of the sign and direction of the magnetic eld, and is only weakly temperature dependent. The M R e ect appears to be a bulk e ect related to the hole current.

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